



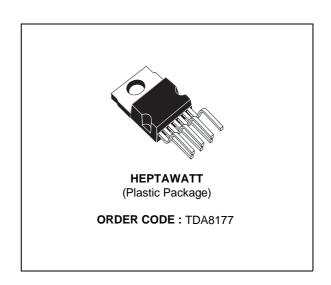
# **VERTICAL DEFLECTION BOOSTER**

- POWER AMPLIFIER
- FLYBACK GENERATOR
- THERMAL PROTECTION
- OUTPUT CURRENT UP TO 3.0APP
- FLYBACK VOLTAGE UP TO 70V (on Pin 5)
- SUITABLE FOR DC COUPLING APPLICATION

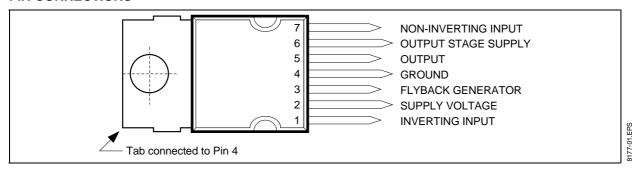
#### **DESCRIPTION**

Designed for monitors and high performance TVs, the TDA8177 vertical deflection booster delivers flyback voltages up to 70V.

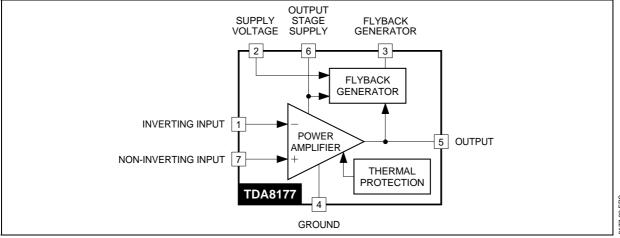
The TDA8177 operates with supplies up to 35V and provides up to 3APP output current to drive the yoke. The TDA8177 is offered in HEPTAWATT package.



#### **PIN CONNECTIONS**



# **BLOCK DIAGRAM**



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#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vs	Supply Voltage (Pin 2) (see note 1)	40	V
V <sub>6</sub>	Flyback Peak Voltage (Pin 6) (see note 1)	75	V
$V_1$ , $V_7$	Amplifier Input Voltage (Pins 1-7) (see note 1)	- 0.3, + V <sub>S</sub>	V
Ιο	Maximum Output Peak Current (see notes 2 and 3)	2.5	Α
l <sub>3</sub>	Maximum Sink Current (first part of flyback) (t < 1ms)	2.5	Α
l <sub>3</sub>	Maximum Source Current (t < 1ms)	2.5	Α
$V_{ESD}$	Electrostatic Handling for all pins (see note 4)	2000	V
T <sub>oper</sub>	Operating Ambient Temperature	- 20, + 75	°C
T <sub>stg</sub>	Storage Temperature	- 40, + 150	°C
Tj	Junction Temperature	+150	°C

- Notes: 1. Versus Pin 4.

  2. The output current can reach 4A peak for t ≤ 10μs (up to 120Hz).

  3. Provided SOAR is respected (see Figures 1 and 2).

  4. Equivalent to discharging a 100pF capacitor through a 1.5kΩ series resistor.

### **THERMAL DATA**

Symbol	Parameter	Value	Unit	
R <sub>th (j-c)</sub>	Junction-case Thermal Resistance Max.	3	°C/W	
Tt	Temperature for Thermal Shutdown	150	°C	
T <sub>jr</sub>	Recommended Max. Junction Temperature	120	°C	

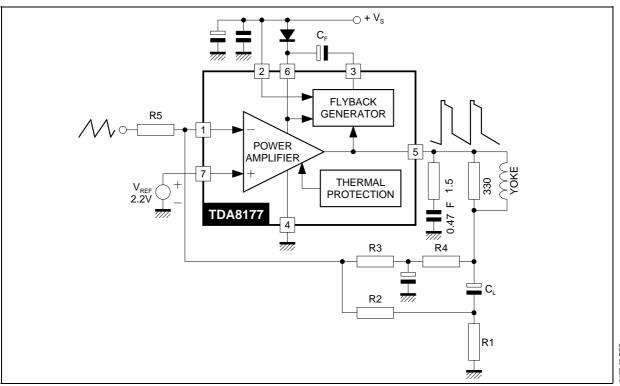
#### **ELECTRICAL CHARACTERISTICS**

 $(V_S = 35V, T_A = 25^{\circ}C, unless otherwise specified)$ 

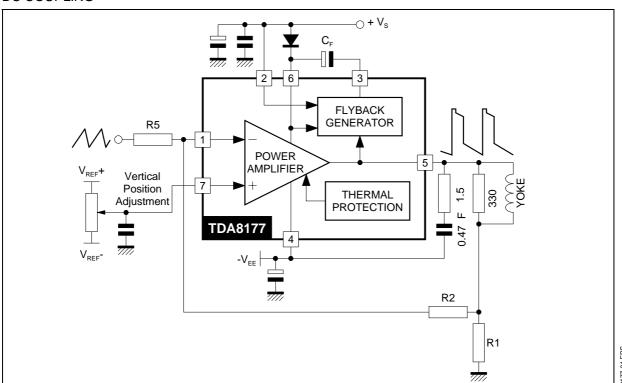
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Vs	Operating Supply Voltage Range		10		35	V
l <sub>2</sub>	Pin 2 Quiescent Current	$I_3 = 0, I_5 = 0$		9	20	mA
I <sub>6</sub>	Pin 6 Quiescent Current	$I_3 = 0$ , $I_5 = 0$ , $V_6 = 35V$	8	15	30	mA
Ιο	Max. Peak Output Current				1.5	Α
I <sub>1</sub>	Amplifier Bias Current	$V_1 = 22V, V_7 = 23V$		- 0.15	- 1	μΑ
l <sub>7</sub>	Amplifier Bias Current	$V_1 = 23V, V_7 = 22V$		- 0.15	- 1	μΑ
V <sub>IO</sub>	Offset Voltage				7	mV
$\Delta V_{IO}/dt$	Offset Drift versus Temperature			- 10		μV/°C
GV	Voltage Gain		80			dB
$V_{5L}$	Output Saturation Voltage to GND (Pin 4)	I <sub>5</sub> = 1.5A		1	1.7	V
$V_{5H}$	Output Saturation Voltage to Supply (Pin 6)	I <sub>5</sub> = - 1.5A		1.8	2.3	V
V <sub>D5 - 6</sub>	Diode Forward Voltage between Pins 5-6	I <sub>5</sub> = 1.5A		1.8	2.3	V
V <sub>D3 - 2</sub>	Diode Forward Voltage between Pins 3-2	I <sub>3</sub> = 1.5A		1.6	2.2	V
V <sub>3SL</sub>	Saturation Voltage on Pin 3	I <sub>3</sub> = 20mA		0.4	1	V
V <sub>3SH</sub>	Saturation Voltage to Pin 2 (2nd part of flyback)	I <sub>3</sub> = - 1.5A		2.1	2.8	V

### **APPLICATION CIRCUITS**

# AC COUPLING



## DC COUPLING



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Figure 1: Output Transistors SOA (for secondary breakdown)

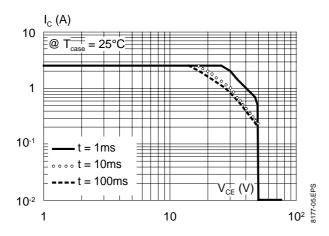
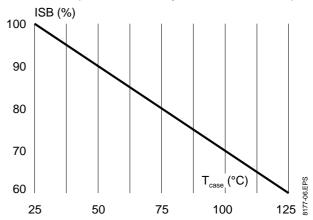
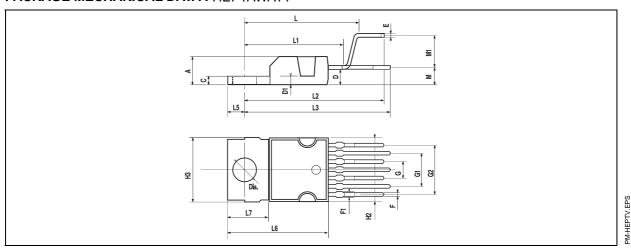


Figure 2 : Secondary Breakdown Temperature
Derating Curve
(ISB = secondary breakdown current)



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### **PACKAGE MECHANICAL DATA:** HEPTAWATT



Millimeters Inches **Dimensions** Min. Max. Min. Max. Тур. Typ. 4.8 0.189 С 1.37 0.054 D 2.4 0.094 0.110 2.8 D1 1.35 0.047 0.053 1.2 0.55 0.014 0.022 0.35 Ε F 80 0.024 0.031 0.6 F1 0.9 0.035 G 2.41 2.54 2.67 0.095 0.100 0.105 5.21 0.205 G1 4.91 5.08 0.193 0.200 G2 7.49 7.62 7.8 0.295 0.300 0.307 H2 10.4 0.409 Н3 10.05 10.4 0.396 0.409 16.97 0.668 L1 14.92 0.587 21.54 0.848 L2 22.62 0.891 L3 L5 0.102 2.6 3 0.118 15.8 0.594 0.622 L6 15.1 0.260 L7 6 6.6 0.236 M 2.8 0.110 M1 5.08 0.200 3.65 3.85 0.144 Dia. 0.152

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